

Electronic Acknowledgement Receipt

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Application Number:	10055310
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Title of Invention:	Temperature controlled semiconductor processing chamber liner
First Named Inventor:	Hamid Noorbakhsh
Customer Number:	32588
Filer:	Keith M. Tackett/Tammi Thomas
Filer Authorized By:	Keith M. Tackett
Attorney Docket Number:	4150D1/ETCH/DRIE/JB1
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		4150D1Y2_ROA_EF.pdf	733797	yes	16

	Multipart Description		
	Doc Desc	Start	End
	Amendment - After Non-Final Rejection	1	8
	Applicant Arguments/Remarks Made in an Amendment	9	16

Warnings:

Information:

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 If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371
 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.